CN87L0XX



highly accurate low dropout voltage regulator (LDO)

deliver up to 300mA of current while consuming only 0.6uA of quiescent curren

■ Introduction

CN87L0XX is a highly accurate low dropout voltage regulator manufactured in CMOS processes. It can deliver up to 300mA of current while consuming only 0.6uA of quiescent current. It consists of a reference voltage generator, an error amplifier, a current foldback circuit, and a phase compensation circuit plus a driver transistor.

■ Features

Ultra-low Quiescent Current: 600nA

Highly Accurate: ±2%

Dropout Voltage: 60mV@IOUT=100mA

Maximum Output Current: 300mA

Input Voltage Range: 1.4V~7.0V

Temperature Stability: ±50ppm/℃

ON/OFF Logic = Enable High

Standby Current: 10nA

 COUT Discharge Circuit when EN Disable is

Active

Protections Circuits: Current Limiter,
 Short Circuit, Foldback

Output Capacitor: Low ESR Ceramic
 Capacitor Compatible

APPLICATIONS

Smart wearer

Long-life battery-powered devices

 Portable mobile devices, such as mobile phones, cameras, and so on

Wireless communication equipment

■ Product Selections:

Туре	Output Voltage	Curren t Limit	Accuracy	Package	MARKING
87L018	1.8V	450mA	±2%	DFNWB-4L\SOT89-3L\SOT23-5 L\SOT23-3L	CN87L018
87L028	2.8V	450mA	±2%	DFNWB-4L\SOT89-3L\SOT23-5 L\SOT23-3L	CN87L028
87L030	3.0V	450mA	±2%	DFNWB-4L\SOT89-3L\SOT23-5 L\SOT23-3L	CN87L030
87L033	3.3V	450mA	±2%	DFNWB-4L\SOT89-3L\SOT23-5 L\SOT23-3L	CN87L033
87L036	3.6V	450mA	±2%	DFNWB-4L\SOT89-3L\SOT23-5 L\SOT23-3L	CN87L036

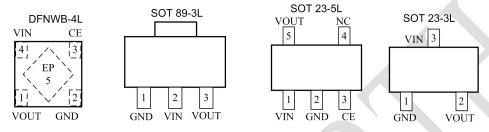
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■ Order Information

Part NO.	Package Type	Qty	Mark*
	DFNWB-4L (1X1)	10000 /Tape	
CN87L0XX	SOT89-3L	1000 /Tape	CN87LXXX/YYWW
	SOT23-5L	3000 /Tape	

■ PIN CONFIGURATION(TOP VIEW):



■ Absolute Maximum Ratings: (Unless otherwise indicated: T_a=25°C)

		(Cinoco otrioi mico maioatoa	u = v /
PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V _{IN}	-0.3 ~ 7.0	V
Output Voltage	V _{OUT}	/ _{OUT} -0.3 ~ V _{IN} +0.3V	
Power Dissipation	P _D	DFNWB-4L 100 SOT23-3L 250 SOT23-5L 250 SOT89-3L 500	mW
Operating Ambient Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +125	°C
ESD Protection	ESD HBM	6000	V

Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.

■ ELECTRICAL CHARACTERISTICS:

CN87L0XX Series(Unless otherwise indicated : T_a=25 °C)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Vout(s)	$V_{IN}=V_{OUT(S)}+2.0V$		V _{OUT(S}		
Outro		I _{OUT} =10mA, V _{OUT(S)} <	V _{OUT(S)} -0.0		V _{OUT(S)} +0.0	
Output Voltage*1		2.0V				V
voitage '		V _{IN} =V _{OUT(S)} +1.0V	V _{OUT(S)} ×0.9		V10	
		I _{OUT} =10mA,			V _{OUT(S)} ×1.0 2	
		V _{OUT(S)} ≥2.0V	V _{OUT(S)} ≥2.0V			



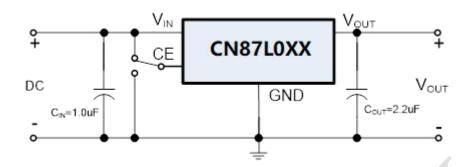
		V _{CE} =V _{IN} , V _{OUT} < 3V		70		
Dropout	V_{DROP}	I _{OUT} =100mA				mV
Voltage*2		V _{CE} =V _{IN} , V _{OUT} ≥3V I _{OUT} =100mA		60		
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \bullet V_{OUT(s)}}$	$V_{OUT(S)}$ +0.5 V \leq 7 V I_{OUT} =10mA		0.05	0.1	%/V
Load Regulation	$\Delta V_{ ext{OUT2}}$	$V_{IN}=V_{CE}=V_{OUT(S)}+1.0V$ $1mA \le I_{OUT} \le 100mA$		6	20	mV
Temperature Stability	$\frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT(s)}}$	$V_{\text{IN}}=V_{\text{CE}}=V_{\text{OUT(S)}}+1.0V$ $I_{\text{OUT}}=1\text{mA}$ $-40^{\circ}\text{C} \leq T_{\text{a}} \leq 85^{\circ}\text{C}$		±50		ppm/℃
GND Current	I _{GND}	no load		0.6	0.9	uA
(CE=V _{IN})	IGND	I _{OUT} =100mA		40		uA
Shutdown Current (CE=0)	Ізнит	V _{IN} =7.0V, V _{CE} =0		0.01	0.1	uA
Input Voltage	V _{IN}		1.5		7	V
Maximum Output Current	Гоитмах	~ \	250	300		mA
Current Limit*2	I _{LIM}	$V_{IN}=V_{CE}=V_{OUT(S)}+1.0V$ $V_{OUT}=0.95 \times V_{OUT(S)}$	300	470		mA
Short Circuit Current	I _{SHORT}	V _{IN} =V _{CE} =V _{OUT(S)} +1.0V V _{OUT} =0V		65		mA
C _{OUT} Auto Discharge	R _{DCHG}	V _{CE} =0, V _{OUT} =V _{OUT(S)}	280	450	640	Ω
Power Supply		f=10Hz, V _{OUT(S)} =2.5V		60		
Rejection Ratio	PSRR	f=100Hz, V _{OUT(S)} =2.5V		45		dB
		f=1kHz, V _{OUT(S)} =2.5V		25		
CE 'H' Level Voltage	V _{CEH}		1.0		6.0	V
CE 'L' Level Voltage	V _{CEL}		0		0.38	v
CE 'H' Level Current	Ісен	V _{IN} =6.0V, V _{CE} =V _{IN}	-0.1		0.1	
CE 'L' Level Current	I _{CEL}	V _{IN} =6.0V, V _{CE} =0	-0.1		0.1	- uA

Notes:

- 1. $V_{OUT(S)}$: Output voltage when $V_{IN}=V_{OUT}+2V$, $I_{OUT}=1$ mA.
- 2. $V_{DROP}=V_{IN1}$ ($V_{OUT(S)}\times$ 0.98) where V_{IN1} is the input voltage when $V_{OUT}=V_{OUT(S)}\times$ 0.98.
- 3. I_{LIM} : Output current when V_{IN} = $V_{OUT(S)}$ +2V and V_{OUT} = $0.95*V_{OUT(S)}$.



■ TYPICAL APPLICATIONS:



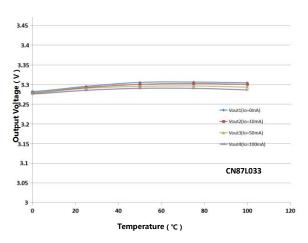
Notes on Use:

Input Capacitor (C_{IN}): 1.0 μ F above Output Capacitor (C_{OUT}):0.1 μ F above

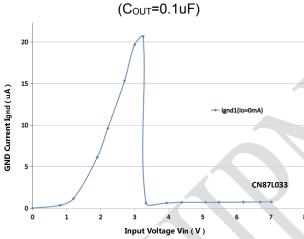


■ TYPICAL PERFORMANCE CHARACTERISTICS:

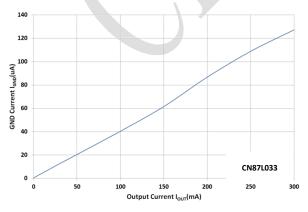
Test Conditions: $V_{IN}=V_{OUT}+1.0V$, $C_{IN}=1.0uF$, $C_{OUT}=0.1uF$ or 1.0uF, $T_a=25\,^{\circ}\mathrm{C}$, unless otherwise indicated.



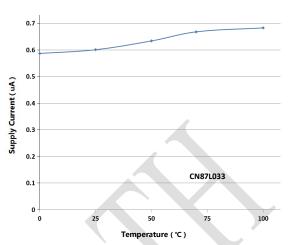
Output Voltage vs. Temperature



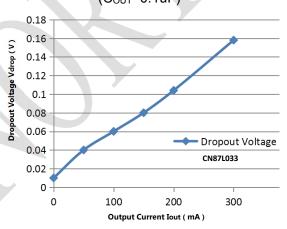
GND Current vs. Input Voltage (C_{OUT}=0.1uF)



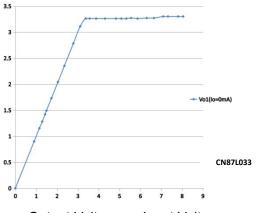
GND Current vs Output Current (C_{OUT}=1.0uF)



Supply Current vs. Temperature (C_{OUT}=0.1uF)



Dropout Voltage vs. Output Current (C_{OUT}=0.1uF)

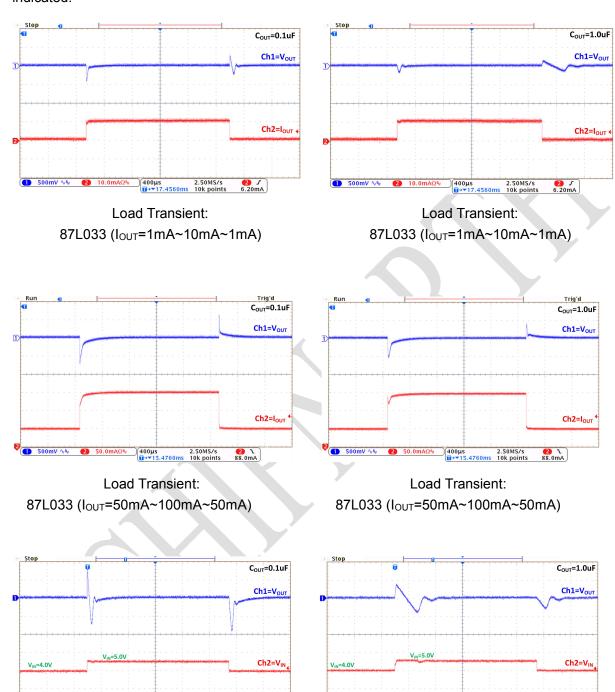


Output Voltage vs Input Voltage (C_{OUT}=0.1uF,I_{load}=0mA)



■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED):

Test Conditions: $V_{IN}=V_{OUT}+1.0V$, $C_{IN}=1.0uF$, $C_{OUT}=0.1uF$ or 1.0uF, $T_a=25\,^{\circ}\mathrm{C}$, unless otherwise indicated.



Line Transient:

87L033 (I_{OUT}=1mA)

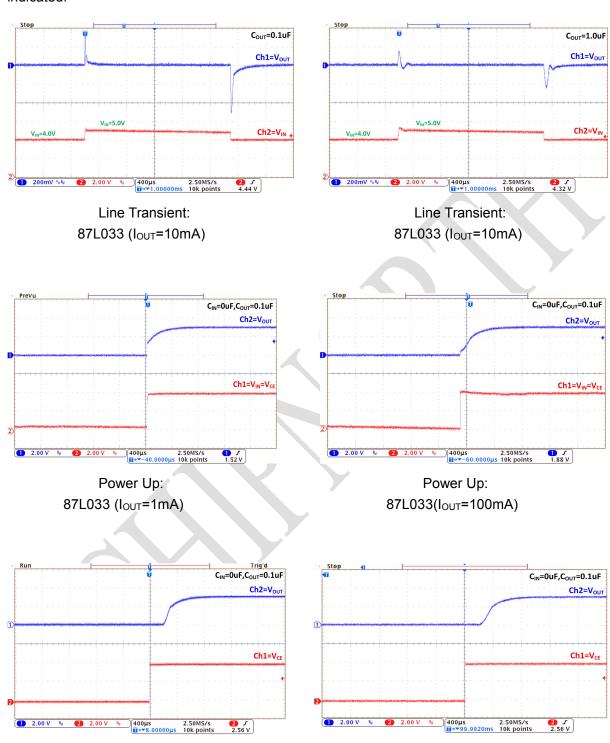
Line Transient:

87L033 (I_{OUT}=1mA)



■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED):

Test Conditions: $V_{IN}=V_{OUT}+1.0V$, $C_{IN}=1.0uF$, $C_{OUT}=0.1uF$ or 1.0uF, $T_a=25\,^{\circ}\mathrm{C}$, unless otherwise indicated.



EN Enable:

87L033 (I_{OUT}=100mA)

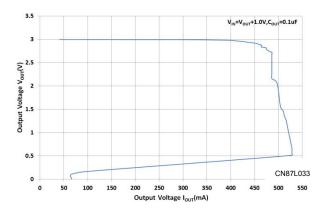
EN Enable:

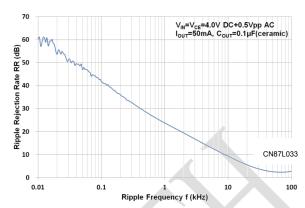
 $87L033(I_{OUT}=1mA)$



■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED):

Test Conditions: $V_{IN}=V_{OUT}+1.0V$, $C_{IN}=1.0uF$, $C_{OUT}=0.1uF$ or 1.0uF, $T_a=25\,^{\circ}\mathrm{C}$, unless otherwise indicated.





87L033 Output Current Fold-back

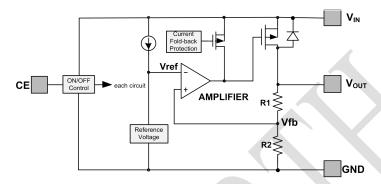
87L033 Power Supply Rejection Ratio



■ OPERATIONAL EXPLANATION:

1. Output voltage control

The voltage divided by resistors R1 and R2 is compared with the internal reference voltage by the error amplifier. The amplifier output then drives the P-channel MOSFET connected to the V_{OUT} pin. The output voltage at the V_{OUT} pin is regulated by this negative feedback system. The current limit circuit and short protect circuit operate in relation to output current level. Further, the IC's internal circuitry can be in operation or shutdown modes controlled by the CE pin's signal.



2. Pass transistor

The pass transistor with low turn-on resistance used inCN87L0XX is a P-channel MOSFET. If the potential on V_{OUT} pin is higher than VIN, it is possible that IC will be destroyed due to reverse current which is caused by parasitic diodes between V_{IN} and V_{OUT} . Therefore, the V_{OUT} pin potential exceeds V_{IN} +0.3V is not allowed.

3. Current foldback and short circuit protection

The CN87L0XX series includes a combination of a fixed current limiter circuit and a foldback circuit, which aid the operations of the current limiter and circuit protection. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. As a result of this drop in output voltage, the foldback circuit operates, output voltage drops further and output current decreases. The short circuit current is about 65mA (typical value). This design can prevent the chip be damaged due to over temperature, moreover, the heat dissipation is limited by the package type.

Special attention should be paid to that the product of the dropout voltage on the chip and the output current must be smaller than the heat dissipation.

4. C_{OUT} Auto-Discharge Function

The CN87L0XX series can quickly discharge the electric charge at the output capacitor (C_{OUT}), when a low signal is set to the CE pin, which puts the whole IC into OFF state. The discharge function is achieved by an internal switch located between the V_{OUT} pin and the GND pin. In this state, the application is protected from a glitch operation caused by the electric charge at the output capacitor (C_{OUT}).

Moreover, discharge time of the output capacitor (C_{OUT}) is set by the C_{OUT} auto-discharge resistance (R_{DCHG}) and the output capacitor (C_{OUT}). By setting time constant of a C_{OUT} auto-discharge resistance value (R_{DCHG}) and an output capacitor value (C_{OUT}) as τ (τ = C_{OUT} x R_{DCHG}), the output voltage after discharge via the internal switch is calculated by the following formulas.

$$V = V_{OUT(S)} \times e^{-t/\tau}$$
 or $t = \tau \ln \left(V_{OUT(S)} / V \right)$



V: Output voltage after discharge

V_{OUT(S)}: Output voltage

t: Discharge time

 $\tau : C_{\mathsf{OUT}} x \ R_{\mathsf{DCHG}}$

Please also note R_{DCHG} is depended on V_{IN} and When V_{IN} is high, R_{DCHG} is low.

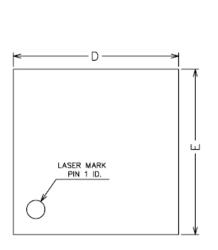
■ Notes:

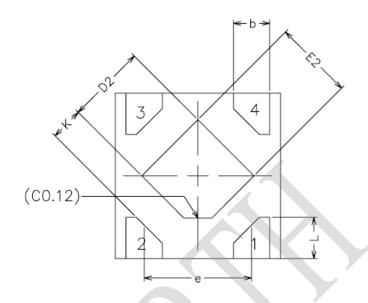
- 1. The input and output capacitors should be placed as close as possible to the IC.
- 2. If the impedance of the power supply is high, which is caused by forgetting installing input capacitor or installing too small value capacitor, the oscillation may occur.
- 3. Pay attention to the operation conditions of input and output voltage and load current, such that the power consumption in the IC should not exceed the allowable power consumption of the package even though the chip has short circuit protection.
- 4. IC has a built-in anti-static protection (ESD) circuit, but please do not add excessive stress to the IC.

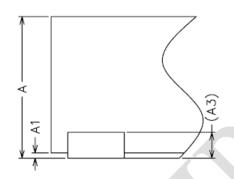
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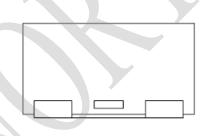


■ PACKAGING INFORMATION:









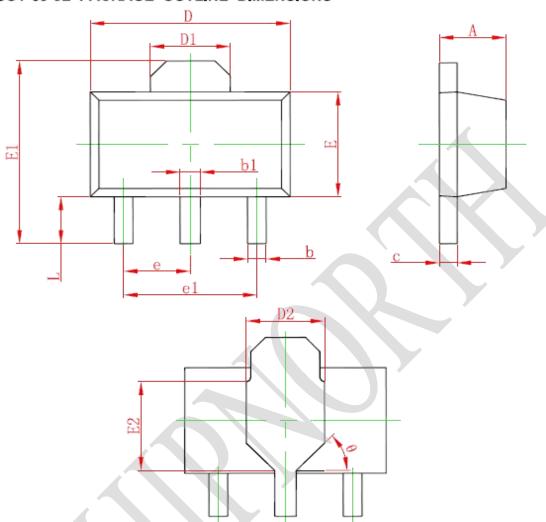
COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
Α	0.50	0.55	0.60
A1	0.00	0.02	0.05
A3	301.00.00	0.100REF	
b	0.17	0.22	0.27
D	0.95	1.00	1.05
E	0.95	1.00	1.05
D2	0.43	0.48	0.53
E2	0.43	0.48	0.53
L	0.20	0.25	0.30
е	0.60	0.65	0.70
K	0.15	_	-



■ PACKAGING INFORMATION(Continued):

SOT-89-3L PACKAGE OUTLINE DIMENSIONS



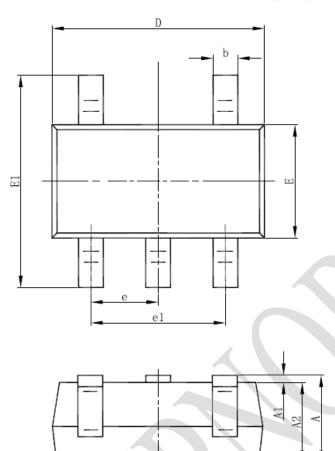
Cymphal	Dimensions In Millimeters		Dimension	ns In Inches	
Symbol	Min.	Max.	Min.	Max.	
Α	1.400	1.600	0.055	0.063	
b	0.320	0.520	0.013	0.020	
b1	0.400	0.580	0.016	0.023	
С	0.350	0.440	0.014	0.017	
D	4.400	4.600	0.173	0.181	
D1	1.550 REF. 0.061 REF.		I REF.		
D2	1.750	REF.	0.069	REF.	
E	2.300	2.600	0.091	0.102	
E1	3.940	4.250	0.155	0.167	
E2	1.900	REF.	0.075	REF.	
е	1.500 TYP.		0.060 TYP.		
e1	3.000 TYP.		0.118	B TYP.	
L	0.900	1.200	0.035	0.047	
θ	4	5°	45°		

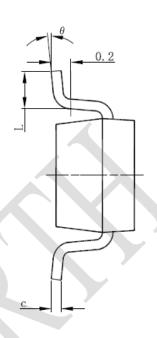
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■ PACKAGING INFORMATION(Continued):

SOT-23-5L PACKAGE OUTLINE DIMENSIONS





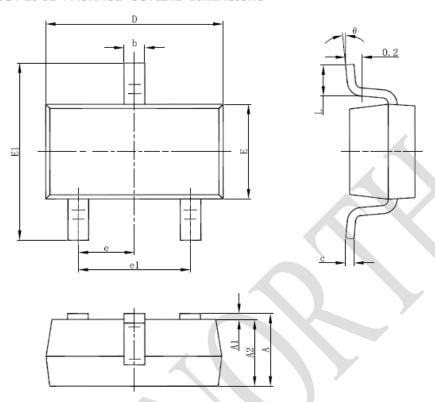
Country	Dimensions In	Millimeters	Dimensions	In Inches
Symbol	Min	Max	Min	Max
Α	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
е	0.950(BSC)	0.037(BSC)
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

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■ PACKAGING INFORMATION(Continued):

SOT-23-3L PACKAGE OUTLINE DIMENSIONS



	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
Α	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
C	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
е	0.950	(BSC)	0.037(BSC)
e1	1.800	2.000	0.071	0.079
	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°



■ ORDER INFORMATION:

date	Version	Revision notes	Reviser
2020.3.6	V1.0	Initial data compilation	ZhangSongfeng



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